(V) WIRE WOUND CHIP INDUCTORS

1. WTI Series (Ceramic Type)

(b). UV glue cover type (Size: 0402(1005)~1008(2520))

Range of Size: (0402(1005)~1008(2520))

Test Equipment: HP4286, 4287A & 4291B - For "Inductance" & "Q" HP4287A & 8753E - For "SRF" HP4287A, GOM-801G & 502BC - For "DCR"

Operating Temperature: -40 ~+105

Applications

- > Cordless (DECT/CT1CT2) & Cellular (CDMA/GSM/PHS) Phone.
- > Remote control, wireless security system.
- > WLL, Wireless LAN / Mouse / Keyboard / Earphone.
- > GPS receiver.
- > VCO, RF Module & other wireless products.
- > CATV Filter, Tuner.
- > Cable Modem / XDSL Tuner.
- > Set Top Box.

Features

- > Wirewound ceramic construction provide high SRF.
- > Ultra compact inductors provide exceptional Q values.
- > Low Profile, high Q are available.
- > Outstanding endurance from Pull-up force, mechanical shock and pressure.

Е

> Smaller size of 0402(1005) & tighter tolerance down to +/- 2%.

В

General Dimensions and Configuration

SHAPE:

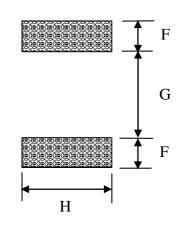


А

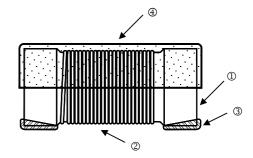
Series	Unit	А	В	С	Е	F	G	Н
WTI-0402C	mm	1.15±0.1	0.70±0.1	0.60±0.1	0.20	0.36	0.46	0.66

С

PCB PATTERN







Construction

- 1. Ceramic Core
- 2. Wire
- 3. Electrode
- 4. UV Glue

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Operating Temperature : -40 ~+125

Inductance, SRF, Q and Rated Current ranges

SERIES	Inductance (nH)	SRF (Min.) (GHz)	Q (Min.)	I (Rated) (mA)
WTI-0402C	1.00~68	12.700~1.620	15~25	1360~100
WTI-0603C	1.60~390	12.500~0.900	16~40	700~100
WTI-0805C	2.70~4700	7.900~0.188	15~65	600~90
WTI-1008C	10.00~3900	4.100~0.100	20~65	1000~260

Color Coding

Color	Figures	Multiplier	
Black	0	1	
Brown	1	10	
Red	2	100	
Orange	3	1000	
Yellow	4	10000	
Green	5	-	
Blue	6	-	
Violet	7	-	
Gray	8	-	
White	9	-	

 WTI-0402C Series

 No Color Coding

 WTI-0603C, WTI-0805C Series

 Because of small size, these parts are marked with a single color dot.

 IDENTIFIER(GRAY)

 Ex : WTI-0805C-33NJ

 MARKING : GRAY

 WTI-1008C Series

 These parts are marked with 3 color dots.

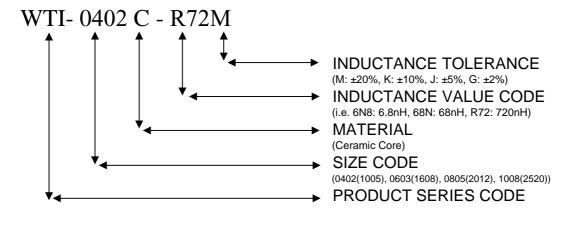
 Part Parts Parts are in nano Henries.

 WARKING : Dots 1 and 2 indicate the inductance in nano Henries.



(DOT 1 : BROWN , DOT 2 : BLACK) MARKING : Dot 3 indicates number of zeroes to be added. (DOT 3 : BLACK)

Part Numbering Systems



(V) WIRE WOUND CHIP INDUCTORS

1(b). WTI Series (UV glue cover) (Size: 0402(1005)~1008(2520))

Electrical Characteristics

WTI-0402C Series Wire Wound Chip Inductors / UV Glue Cover Type

PART NUMBER	INDUCTANCE (µ H)	Rdc() ±30%	Isat (A) Typ.(Max)	Irms (A) Typ.	TOLERANCE
WTI-0402C-R72M	0.72@7.9MHz	0.27	0.48(0.45)	0.8	М, Т

- 1、Test equipment :
 - L/Q/DCR : E4982A + Agilent 16197A
- 2、 Isat : For Inductance drop 30% from its value without current.
- 3、 Irms for a 40 rise above 25 ambient.
- 4、 Operating temperature : -40 ~+105 .
- 5、Storage Temperature: 20 ~25 , Humidity < 65%RH

1. Environmental Performance							
No.	Item	Specification	Test Method				
1-1	Temperature Cycle		One Cycle: Step Temperature () Time (min.) 1 -40±3 30 2 25±2 3 30 2 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 4 25±2 3 30 30 4 25±2 3 30				
1-2	Static Humidity	Appearance: No Damage L : Within Spec Q : Within Spec	Temperature: 85±2 Relative Humidity: 90 ~ 95% Time: 24Hrs Measured After Exposure In The Room Condition For 2Hrs				
1-3	High Temperature Resistance			m Condition For 2Hrs			
1-4	Low Temperature Resistance		Temperature: -40±3 Time: 48±12Hrs Measured After Exposure In The Room Condition For 2Hrs				

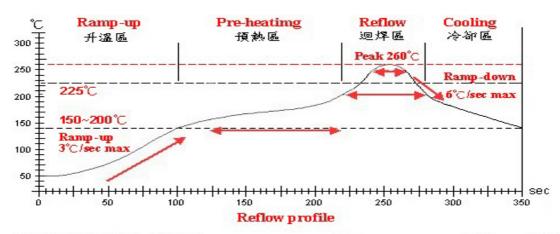
(V) WIRE WOUND CHIP INDUCTORS

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2. Mechanical Performance

No.	Item	Specification	Test Method
2-1	Resistance To Soldering Heat	Appearance: No Damage	 Pre-Heating: 150 , 1min. Solder Composition: Sn96.5/Ag3.0. Solder Temperature: 260±5 . Immersion Time: 10±1sec.
2-2	Solderability	The Electrodes Shall Be At Least 90% Covered With New Solder Coating	 Pre-Heating: 150 , 1min. Solder Composition: Sn/Ag3.0/Cu0.5 . Solder Temperature: 255±5 . Immersion Time: 4±1sec.
2-3	Component Adhesion (Push Test)	1 Lbs. For 0402 1 Lbs. For 0603 2 Lbs. For 0805 2 Lbs. For 1008	The Device Should Be Reflow Soldered (255 ±5 For 10 Seconds) To A Tinned Copper Substrate. A Force Gauge Should Be Applied To The Side Of The Component. The Device Must Withstand A Minimum Force Of 1 Or 2 Pounds Without A Failure Of The Termination Attached To Component.
2-4	Vibration	Appearance: No Damage L, Q: Within Spec.	 Solder specimen inductor on the test printed circuit board. Apply vibrations in each of the x,y and z directions for 2 hours for a total of 6 hours. Freq:10~50Hz, Amplitude: 1.5mm

3. Recommended Lead-Free IR Reflow Conditions



Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

	1/4 -1 (mm / 20 / 2 / 1/1				
管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150℃	150° C ~ 200° C	225° C	260±5℃	Peak Temp. ~ 150℃
實際時間 Time result		60~180 sec	20 ~ 60 sec	5 ~ 10 sec	—

NOTE :

- 1. Re-flow possible times : within 2 times
- 2. Nitrogen adopted is recommended while in re-flow